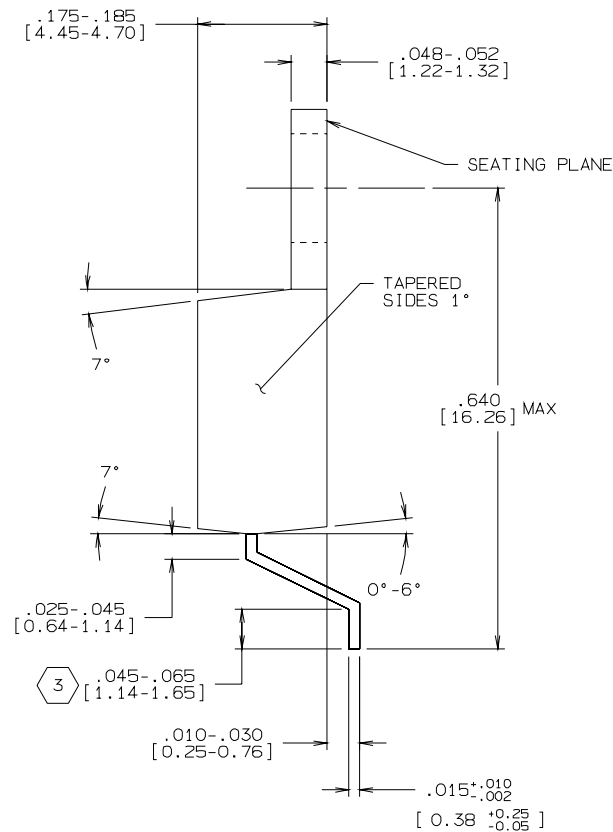
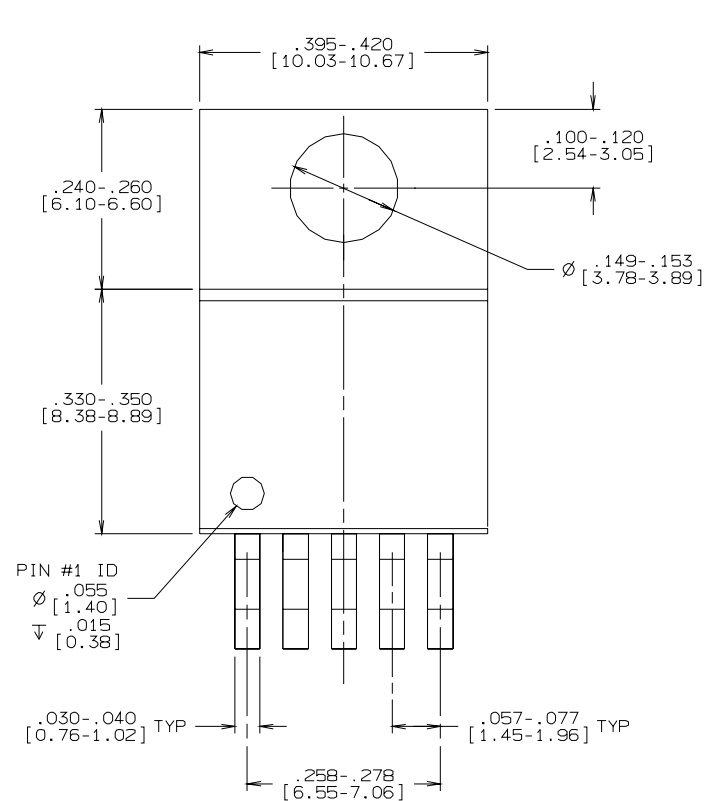


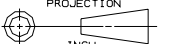
R E V I S I O N S			
LTR	DESCRIPTION	E.C.N.	DATE BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	08642	06/21/91 DEG/



NOTES: UNLESS OTHERWISE SPECIFIED

- MOLDED CORNERS SHOWN SHARP R .031 [0.79] MAXIMUM.
- STANDARD LEAD FINISH:
200 MICROINCHES / 5.08 MICROMETERS MINIMUM LEAD/TIN
ON OLIN 194 OR EQUIVALENT.
- FOOT AREA.
- ALL INTERNAL LEAD BENDING RADII SHALL BE
.025 +.010 -.005 [0.64 +0.25 -0.13].

CONTROLLING DIMENSION: INCH

APPROVALS		DATE		 NATIONAL SEMICONDUCTOR CORPORATION 2900 Semiconductor Drive, Santa Clara, CA 95052-8090 TO-220, MOLDED, SURFACE MOUNT, 5 LEAD					
DRAWN		D.E. GRADY						06/21/91	
DFTG. CHK.									
ENGR. CHK.									
APPROVAL									
 PROJECTION INCH [MM]				SCALE	SIZE	DRAWING NUMBER		REV	
				N/A	C	MKT-TA05A		A	
				DO NOT SCALE DRAWING		SHEET 1 OF 1			